REVISIONS		
#	DESCRIPTION	DATE

NOTES

Allow clearance for finger squeeze access from the two sides shown.

No tracks or vias in the shaded keepout area.

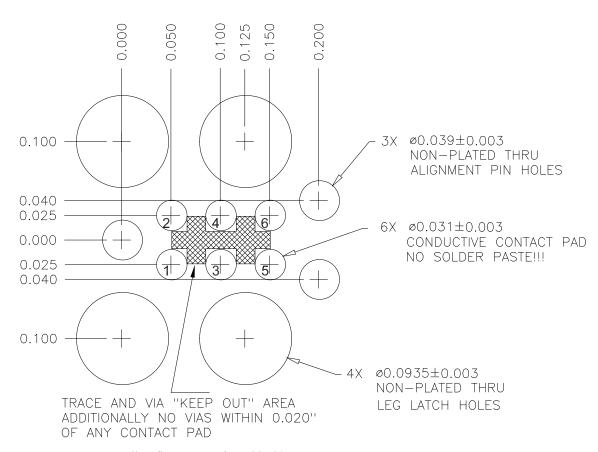
No other track or signal within 0.020" of any contact pad.

Do not allow solder paste on the contact pads. It is essential to eliminate any hole in the solder paste-mask (solder stencil) layer. If this is not possible make the contact pads thru-hole with finished hole size of 0.008" or less.

Leg and alignment holes may be plated and used as vias but ensure minimum finished hole size meets specified tolerances.

To prevent purchasing confusion, please specify DNL in your BOM!

Allow finger access from this side



Allow finger access from this side

Microchip ICD / ICSP SIGNALS

Pin 1: -MCLR/Vpp

Pin 2: Vdd

Pin 3: Ground

Pin 4: PGD (ICSPDAT) Pin 5: PGC (ICSPCLK)

Pin 6: Unused or LVP

UNLESS OTHERWISE NOTED DIMENSIONS ARE IN INCHES SCALE: 10:1 INFORMATION CONTAINED HEREIN IS THE PROPERTY ANGLE ± .XXX± .XX± OF TAG-CONNECT. THIS INFORMATION SHALL NOT BE DISCLOSED BY THE RECIPIENT WITHOUT WRITTEN DATE 4/5/10 .005 .01 1.5° PM / NS CHECKED DATE Α

THIRD ANGLE PROJECTION

www.TAG-CONNECT.com

TC2030-MCP-FP FOOTPRINT FOR TC2030-MCP

CUSTOMER:

FILE:

DWG. NO. SHEET 1 OF 1

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